

# JNG25T60KS

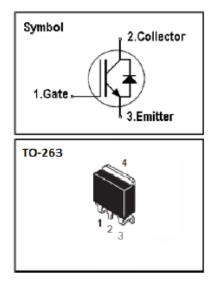
# IGBT

### **Features**

- 600V,25A
- V<sub>CE(sat)(typ.)</sub>=2.1V@V<sub>GE</sub>=15V,I<sub>C</sub>=25A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

## **General Description**

JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as SMPS, general inverter and other switching applications.



## Absolute Maximum Ratings

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	600	V
Vges	Gate-Emitter Voltage	<u>+</u> 20	V
la la	Continuous Collector Current ( Tc=25 °C)	45	А
lc	Continuous Collector Current (Tc=100°C)	25	А
Ісм	Pulsed Collector Current (Note 1)	75	А
lF	Diode Continuous Forward Current ( $T_c=100$ °C)	25	А
IFM	Diode Maximum Forward Current (Note 1)	75	А
t <sub>sc</sub>	Short Circuit Withstand Time	10	us
D	Maximum Power Dissipation (Tc=25 °C)	140	W
PD	Maximum Power Dissipation (Tc=100°C)	55	W
TJ	Operating Junction Temperature Range	-55 to +150	°C
Tstg	Storage Temperature Range	-55 to +150	°C

# **Thermal Characteristics**

Symbol	Parameter	Max.	Units	
R <sub>th j-c</sub>	Thermal Resistance, Junction to case for IGBT	0.9	°C/ W	
R <sub>th j-c</sub>	Thermal Resistance, Junction to case for Diode	1.2	°C/ W	
R <sub>th j-a</sub>	Thermal Resistance, Junction to Ambient	40	°C/ W	



## Electrical Characteristics (Tc=25°C unless otherwise noted )

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	$V_{GE}$ = 0V, I <sub>C</sub> = 250uA	600	-	-	V
I <sub>CES</sub>	Collector-Emitter Leakage Current	V <sub>CE</sub> = 600V, V <sub>GE</sub> = 0V	-	-	100	uA
1	Gate Leakage Current, Forward	$V_{GE}$ =30V, $V_{CE}$ = 0V	-	-	100	nA
I <sub>GES</sub>	Gate Leakage Current, Reverse	$V_{GE}$ = -30V, $V_{CE}$ = 0V	-	-	100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 250 uA$	4.5	-	6.5	V
$V_{\text{CE(sat)}}$	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> = 25A	-	2.1	2.6	V
Qg	Total Gate Charge	V <sub>cc</sub> =400V V <sub>GE</sub> =15V	-	62		nC
Q <sub>ge</sub>	Gate-Emitter Charge		-	8		nC
Q <sub>gc</sub>	Gate-Collector Charge	I <sub>C</sub> =25A	-	32		nC
t d(on)	Turn-on Delay Time		-	20	-	ns
t r	Turn-on Rise Time	Vcc=400V	-	27	-	ns
t d(off)	Turn-off Delay Time	V <sub>GE</sub> =15V	-	200	-	ns
t f	Turn-off Fall Time	Ic=25Α R <sub>G</sub> =28Ω	-	24	-	ns
Eon	Turn-on Switching Loss	Inductive Load Tc=25 °C	-	0.65	-	mJ
Eoff	Turn-off Switching Loss		-	0.28	-	mJ
Ets	Total Switching Loss		-	0.93	-	mJ
Cies	Input Capacitance	V <sub>CE</sub> =25V	-	900	-	pF
Coes	Output Capacitance	V <sub>GE</sub> =0V	-	285	-	pF
Cres	Reverse Transfer Capacitance	f = 1MHz	-	70	-	pF

# Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

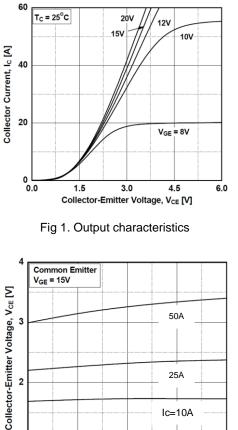
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> =25A	-	1.6	2.0	V
trr	Diode Reverse Recovery Time	V <sub>CE</sub> = 400V	-	85		ns
Irr	Diode peak Reverse Recovery Current	I <sub>F</sub> = 25A	-	14		А
Q <sub>r r</sub>	Diode Reverse Recovery Charge	dIF/dt = 200A/us	-	200		nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



### **Typical Performance Characteristics**



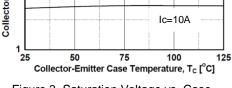


Figure 3. Saturation Voltage vs. Case Temperature at Variant Current Level

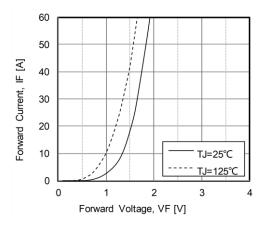
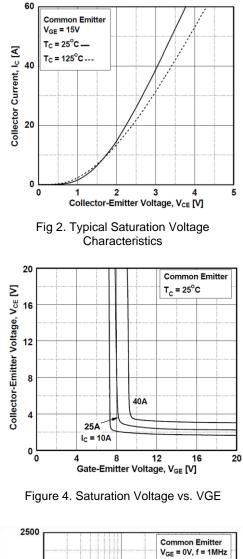


Figure 5. Forward Characteristics



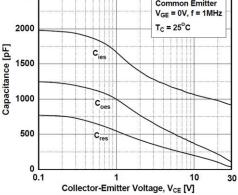
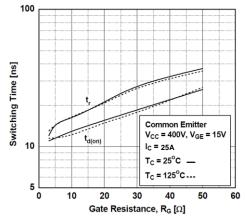
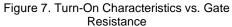


Figure 6. Capacitance Characteristics



### **Typical Performance Characteristics**





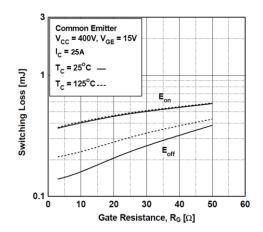
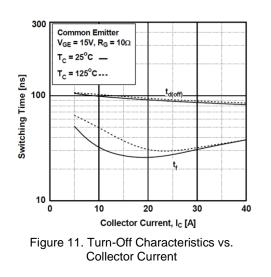
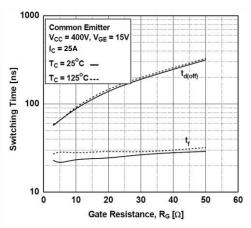
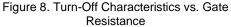


Figure 9. Switching Loss vs. Gate Resistance







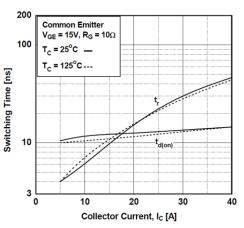
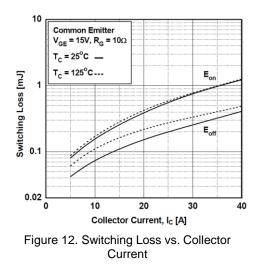


Figure 10. Turn-On Characteristics vs. Collector Current





### **Typical Performance Characteristics**

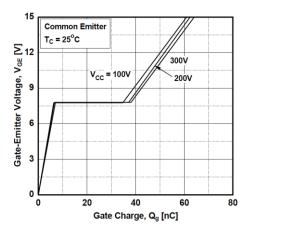


Figure 13. Gate Charge Characteristics

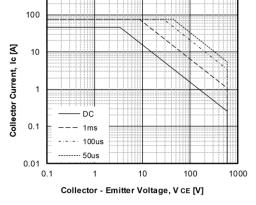
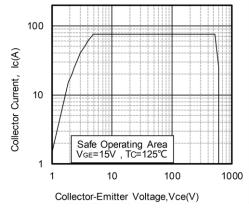
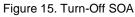


Figure 14. SOA Characteristics





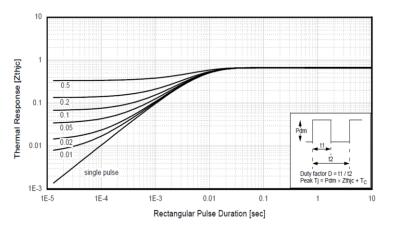
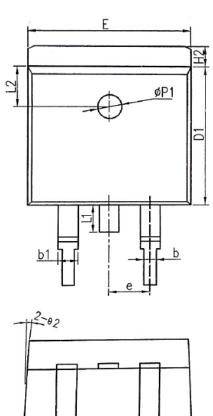


Figure 19. Transient Thermal Impedance of IGBT

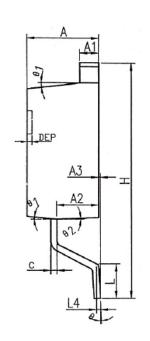


# JNG25T60KS

# 封装外型



SYMBOL	MM			
STIVIBUL	MIN	NOM	MAX	
А	4.40	4.57	4.70	
A1	1.22	1.27	1.32	
A2	2.59	2.59 2.69 2.		
A3	0.00	0.10	0.20	
b	0.77	0.813	0.90	
b1	1.20	1.27	1.36	
С	0.34	0.381	0.47	
D1	8.60	8.70	8.80	
E	10.00	10.16	10.26	
E2	10.00	10.10	10.20	
е	2.54 BSC			
н	14.70	0 15.10 15.50		
H2	1.17	1.27	1.40	
L	2.00	2.30	2.60	
L1	1.45	1.45 1.55 1.70		
L2		2.5 REF		
L4	0.25 BSC			
θ	0°	0° 5° 8°		
θ1	5°	7°	9°	
θ2	1°	1° 3° 5°		
ΦΡ1	1.40	1.50	1.60	
DEP	0.05	0.10	0.20	



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